



	三型	四型	六型	九型
A	7.62	10.16	15.24	22.86
B	4.14	6.68	11.76	19.38
C	10.12	12.66	17.74	25.36

ELECTRICAL:
 CURRENT RATING: 3.0Amps/CONTACT MAX.
 CONTACT RESISTANCE: 20mΩ/CONTACT MAX.
 INSULATION RESISTANCE: 1000MΩ AT V=100V MIN.
 OPERATING VOLTAGE: 60V AC/DC

MECHANICAL
 AVERAGE INSERTION FORCE WITH STEEL PIN OF Ø0.43mm: 250g MAX.
 AVERAGE WITH DRAWAL FORCE WITH STEEL PIN OF Ø0.43mm: 25G MIN.
 MECHANICAL LIFE CYCLE: 200 CYCLE MIN.
 OPERATING TEMPERATURES:
 GOLD PLATED: -55°C TO +125°C
 TIN PLATED: -40°C TO +105°C
 SOLDERING TEMPERATURE: PBT,+240°C,10S MAX.

MATERIAL
 PIN: BRASS, MACHINED
 CLIP: BERYLLIUM COPPER OR PHOSPHOR BRONZE
 INSULATOR BODY(BLACK): PBT OR OTHER(UL94V-0)

PART NO.
 Z-100 * * * * * 0 *
 NO. OF CONTACT: 06~64=06PIN~64PIN
 DIP SPACING: 3=7.62mm, 4=10.16mm, 6=15.24mm, 9=22.86mm
 HOUSING TYPE: 1=WITH BAR, 2=WITHOUT BAR (FOR 6~16PIN ONLY)
 PITCH: 0=2.54mm

LOGO: 0=NEXTRON LOGO, 1=NO LOGO, M=3M LOGO

CODE	PIN PLATED	CLIP PLATED
1001	TIN 200u"	GOLD FLASH
1003	TIN 200u"	GOLD 10u"
1005	TIN 200u"	GOLD 30u"
1007	TIN 200u"	TIN 200u"
1301	GOLD FLASH	GOLD FLASH
1303	GOLD FLASH	GOLD 10u"
1305	GOLD FLASH	GOLD 30u"
1307	GOLD FLASH	TIN 200u"

DESIGN UNITS mm INCH		NAME: 2.54mm IC SOCKET	nexttron NEXTRONICS ENGINEERING CORP.
GENERAL TOLERANCES: (UNLESS SPECIFIED)		OPEN FRAME SOLDER TYPE	
		PART NO: Z-100*****0*	TITLE: CUSTOMER DWG C
4 PLACE ± * ±		APPD: 楊海文 08/17.11	DWG. NO: 010-0000-633
3 PLACE ± * ±		CHKD: 羅旋 08/17.11	SCALE: 1.5 / 1
2 PLACE ± 0.10 ±		DRAWN: 賀秀秋 08/17.11	SHEET: 1 / 1
1 PLACE ± 0.30 ±			REV.: A1
ANGULAR: X° ± 1' X' ±			

A1	MODIFIED PART NO.	8/17.11	Seawen
REV.	DESCRIPTION	DATE	APPD